### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# **TLP3212**

Battery Control

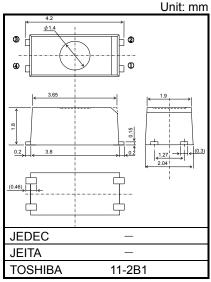
Measuring Instruments

Logic IC Testers / Memory Testers

The TOSHIBA TLP3212 is an ultra-small photorelay suitable for surface-mount assembly. The TLP3212 consists of an infrared emitting diode optically coupled to a photo-MOSFET and is housed in a 4-pin package. Its features include low Off-state current and low output pin capacitance.

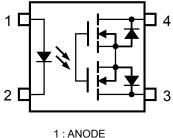
#### **Features**

- 4-pin SSOP (SSOP4): 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak Off-State Voltage: 60 V (min)
- Trigger LED Current: 5 mA (max)
- On-State Current: 400 mA (max)
- On-State Resistance:  $1.5\Omega(max)$ ,  $1.0 \Omega$  (typ.)
- Isolation Voltage: 1500 Vrms (min)
- UL-recognized: UL1577, File No.E67349



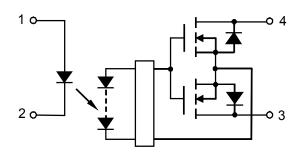
Weight: 0.03 g (typ.)

## Pin Configuration (Top View)



- 2 : CATHODE 3 : DRAIN
- 4 : DRAIN

### **Schematic**



Start of commercial production 2005-07

### **Absolute Maximum Ratings (Ta = 25°C)**

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
	Forward Current Derating (Ta $\geq$ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
ED	Reverse Voltage	VR	5	V
۳	Diode Power Dissipation	PD	50	mW
	Diode Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction Temperature	Tj	125	°C
	Off-State Output Terminal Voltage	Voff	60	V
DETECTOR	On-State Current	Ion	400	mA
	On-State Current Derating (Ta $\geq$ 25°C)	Δl <sub>ON</sub> /°C	-4.0	mA/°C
Ē	Output Power Dissipation	Po	240	mW
	Output Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>O</sub> /°C	-2.4	mW / °C
	Junction Temperature	Tj	125	°C
Stora	ge Temperature Range	T <sub>stg</sub>	-40 to 125	°C
Opera	ating Temperature Range	T <sub>opr</sub>	-20 to 85	°C
Lead	Soldering Temperature (10 s)	T <sub>sol</sub>	260	°C
Isolat	ion Voltage (AC, 60 s, R.H. $\leq$ 60 %) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Note1: Device considered a two-terminal device. Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

## **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V <sub>DD</sub>	_	_	48	V
Forward Current	lF	_	_	20	mA
On-State Current	Ion	_	_	400	mA
Operating Temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the devices. Each item also has its own independent guideline document. In developing designs using these products, please confirm the specified characteristics shown in these documents.

# Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	CT	V = 0 V, f = 1 MHz		15		pF
CTOR	Off-State Current	loff	V <sub>OFF</sub> = 60 V	ı	ı	1	μА
DETECTOR	Capacitance	Coff	V = 0 V, f = 1 MHz, t < 1 s	1	20	1	pF

# **Coupled Electrical Characteristics (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	lFT	ION = 100 mA,	_	2	5	mA
Close LED Current	IFC	IOFF = 10 μA	0.2	_	_	mA
On-State Resistance	Ron	I <sub>ON</sub> = 400 mA, I <sub>F</sub> = 5 mA	_	1.0	1.5	Ω

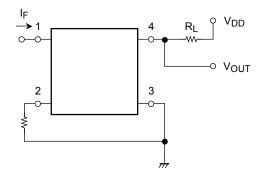
# **Isolation Characteristics (Ta = 25°C)**

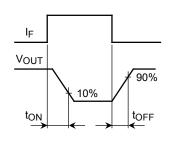
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.3	_	pF
Isolation Resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation Voltage	BVS	AC, 60 s	1500	ı	ı	Vrms

# **Switching Characteristics (Ta = 25°C)**

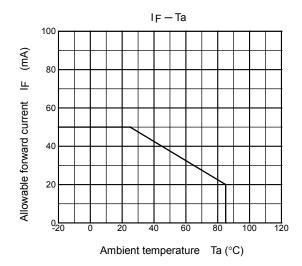
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	ton	$R_L = 200 \Omega$ (Note 2)	_	300	1000	0
Turn-off Time	toff	$V_{DD} = 20 \text{ V, I}_F = 5 \text{ mA}$	_	200	1000	μS

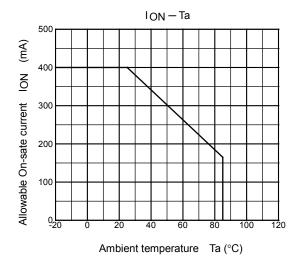
Note 2: Switching time test circuit

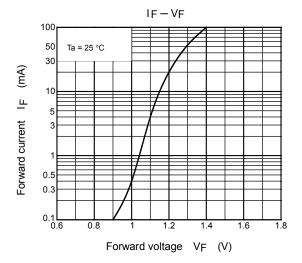


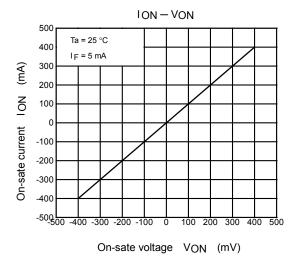


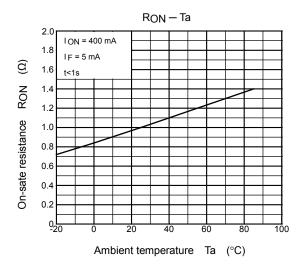
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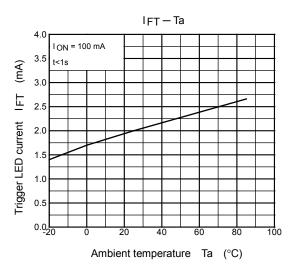




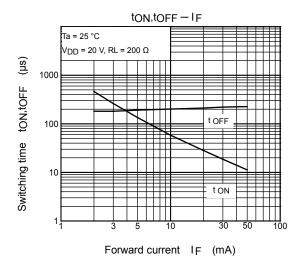


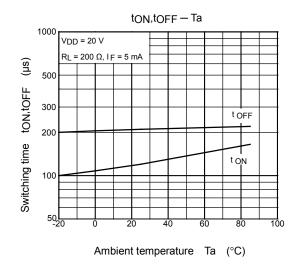


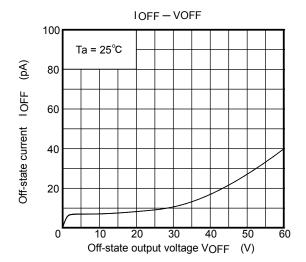


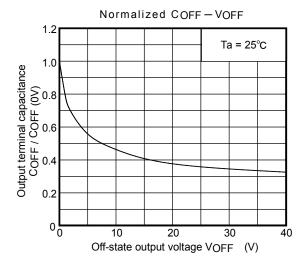


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





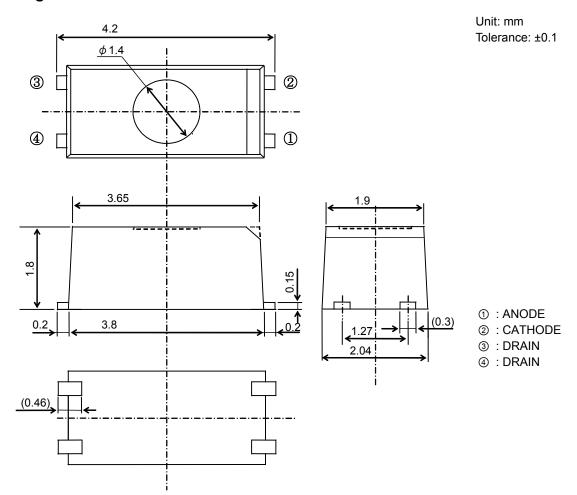




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# **Package Dimensions**



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